



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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PRODUCT DESCRIPTION

Laird Tputty™ 508 is a single part dispensable material designed with automation and vertical stability in mind. Laird has leveraged its knowledge of thermally conductive fillers and resin systems to develop a single part dispensable that demonstrates reliability in a variety of application orientations.

Tputty™ 508 is ideal for applications that can benefit from automation, and allows minimization of SKUs in applications with gap variability. In addition to providing application flexibility and variable gap adaptation, Tputty™ 508 will exert minimum stress on your component while maintaining interface contact to maximize thermal transfer. Combined with Laird's global technical support and global footprint, deploying Tputty™ 508 is easier than ever.

FEATURES AND BENEFITS

- RoHS Compliant
- Complete Dispensing Solution Options Available
- 3.7 W/mK
- Demonstrated thermal cycling stability
- Low outgassing per ASTM E595
- Available in cartridges (75cc, 180cc, 360cc, 600cc) and pails (1 gallon and 5 gallon)

Packaging Size	Fill Volume	Fill Weight
75cc (2.5 oz)	56cc	177g
180cc (6 oz)	159cc	503g
360cc (12 oz)	326cc	1030g
600cc (20 oz)	601cc	1900g
1 gallon	4110cc	13kg
5 gallon	6320cc	20kg

SPECIFICATIONS

PROPERTY	TYPICAL VALUE	METHOD
Construction	Ceramic filled silicone dispensable	N/A
Color	Green	Visual
Thermal Conductivity (w/mK)	3.7	Hot Disk
Flow Rate (75cc taper tip, 0.125" orifice, 40 psi)	50 g/min	Laird Test Method – A16724-00
Density (g/cc)	3.2	Helium Pycnometer
Flammability	V-0	UL 94
Temperature Range	-40 to 150°C	Laird Test Method
Outgassing TML (weight %)	0.04	ASTM E595
Outgassing CVCM (weight %)	0.01	ASTM E595
Dielectric Breakdown	>3000 VAC	ASTM D149
Dielectric Constant @ 1MHz	8.62	ASTM D150
Minimum Bond line Thickness	0.09 mm (0.0036")	Laird Test Method -A16112-00
Volume Resistivity (ohm-cm)	10 ¹³	ASTM D257

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